JC09 Rec'd PCT/PTO 02 AUG 2005

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

FUJIMOTO ET AL

National phase of International Application No. PCT/JP2004/001157

International filing date: February 4, 2004

Date of entry into national phase: August 2, 2005

For:

METHOD OF INTERCONNECTING TERMINALS AND METHOD OF MOUNTING SEMICONDUCTOR DEVICES

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Pursuant to the requirements of 37 CFR §§1.56 and 1.97, the attention of the Examiner is directed to the documents listed on the attached Form PTO-1449. A copy of each listed document is attached. Neither this Statement nor the listing of these documents on Form PTO-1449 is an admission that these documents are prior art as to the Applicants or a representation that a search has been made or that no more pertinent documents exist.

Documents AF and AI - AL were cited in the International Search Report in connection with the international phase of the

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present application. A copy of the Search Report is attached.

Documents AG, AH, AM, and AN are discussed on pages 2 - 4 of the specification of the present application.

The Applicants respectfully request that the listed documents be considered by the Examiner and made of record in the present application.

Respectfully submitted,

Michael Tobias

Registration Number 32,948

Customer No. 27649

#40

1717 K Street, N.W., Suite 613

Washington, D.C. 20036 Telephone: (301) 587-6541 Facsimile: (301) 587-6623

Date: Queyot 2, 2005

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Form PTO-1449 (modified) List of Patent and Publications For Applicant's Information Disclosure Statement (use several sheets if necessary) Page 1 of 1										Atty. Docket. No.:		Intl. Appln. No.: PCT/JP2004/ 001157			
										Applicant: Kozo Fujimoto et al					
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						U	.S. P.	ATEN	NT DOCUME	ENTS					
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